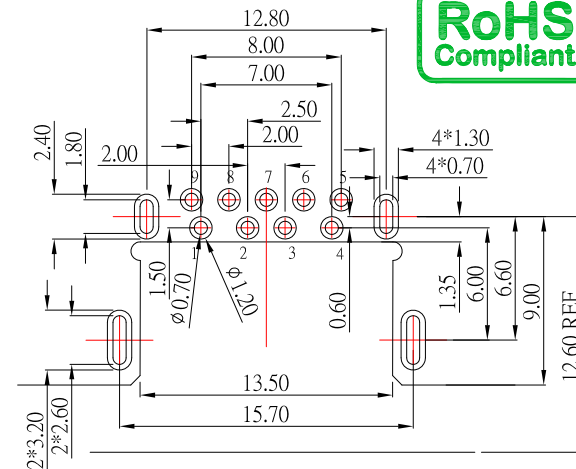




SUA-110E18-30x-S242

鍍層厚度：

Blank : 1u"
2 : 15u"
3 : 30u"



RECOMMENDED PCB LAYOUT

NOTE:

1.MATERIAL:

1.1 Housing: LCP

1.2 Contact: Phosphor Bronze

1.3 Shell: SUS201

2.Finish:

2.1 Contact: Plated Gold in Mating Area ;

Tin Plated on Solder Balls ;

Nickel under plated overall

2.2 Shell: Nickel under Plated surface layer

3.SPECIFICATION:

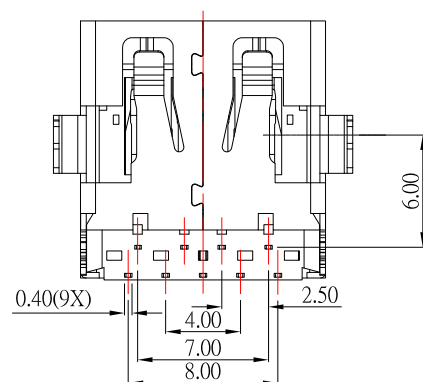
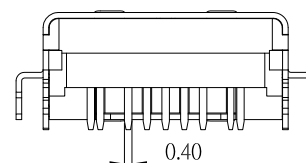
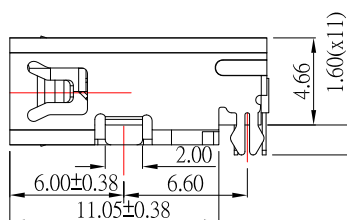
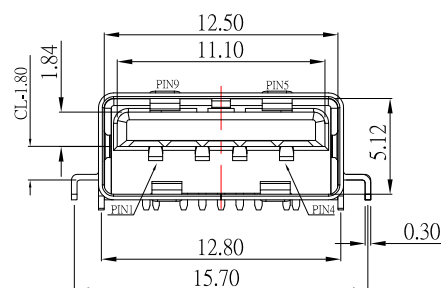
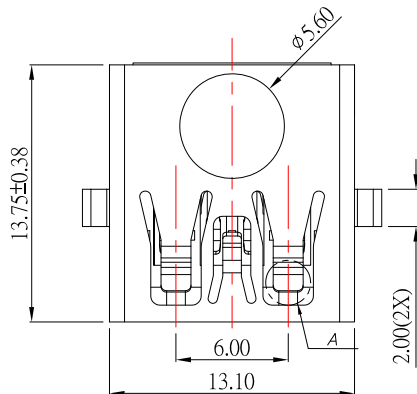
3.1 Rate: 30V DC , 1.5 A

3.2 Insulator Resistance:100M Ω Min

3.3 Dielectric Strength: 500V AC

3.4 Contact Resistance: 30m Ω Max

3.5 Operation Temperature: -55°C ~ +85°C



 東莞市高迪電子有限公司
DONG GUAN GAO DI ELECTRONICS CO., LTD

TOLERANCE UNLESS
OTHERWISE STATED :

Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°

3RD.
ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu
CHECKED BY: Jacky Chen
APPROVED BY: Tony Kao

DATE: 03/29/22
DATE: 03/29/22
DATE: 03/29/22

MAT'L
FINISH
SCALE

TITLE
MODLE
DWG NO.

CONNECTOR
L13.75 無捲邊

SUA-110E18-30x-S242
SUA-110E18-30x-S242

SIZE: A4
VER: R2

ITEM NO	DESCRIPTION	DRAWN	DATE
2	新增尺寸和更新樣式	Jack	032922
1	更新樣式	Jack	032522